

SIDE VIEW

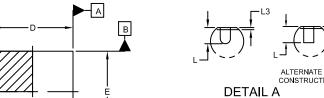
D2

0.08 C

A1-

DETAIL A

NOTE 4



SEATING

-20X L

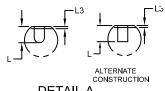
20X b

Ф

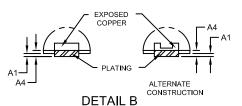
0.10 C A B

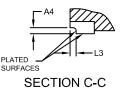
NOTE 3

0.05 C



QFNW20 4x4, 0.5P CASE 484AT **ISSUE O**



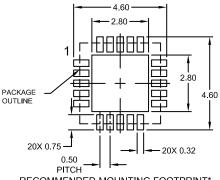


DATE 06 AUG 2019

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2008.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSION b APPLIES TO THE PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 FROM THE TERMINAL TIP.
- 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN.	NOM.	MAX.
Α	0.80	0.90	1.00
A1	0.00		0.05
A3	0.20 REF		
A4	0.10		
b	0.20	0.25	0.30
D	3.90	4.00	4.10
D2	2.60	2.70	2.80
Е	3.90	4.00	4.10
E2	2.60	2.70	2.80
е	0.50 BSC		
k	0.20		
L	0.35	0.40	0.45
L3			0.090



RECOMMENDED MOUNTING FOOTPRINT*

*FOR ADDITIONAL INFORMATION ON OUR P6-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRIMD.

GENERIC MARKING DIAGRAM*

BOTTOM VIEW

16



XXXX = Specific Device Code = Assembly Location

= Wafer Lot Υ = Year W = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	QFNW20 4x4, 0.5P		PAGE 1 OF 1	

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